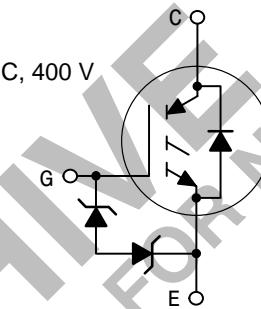


Designer's™ Data Sheet
Insulated Gate Bipolar Transistor
with Anti-Parallel Diode
N-Channel Enhancement-Mode Silicon Gate

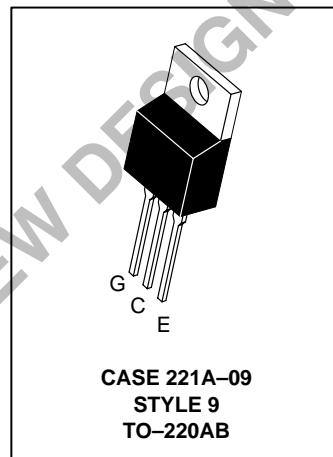
This Insulated Gate Bipolar Transistor (IGBT) is co-packaged with a soft recovery ultra-fast rectifier and uses an advanced termination scheme to provide an enhanced and reliable high voltage-blocking capability. Its new 600 V IGBT technology is specifically suited for applications requiring both a high temperature short circuit capability and a low $V_{CE(on)}$. It also provides fast switching characteristics and results in efficient operation at high frequencies. Co-packaged IGBTs save space, reduce assembly time and cost. This new E-series introduces an energy efficient, ESD protected, and short circuit rugged device.

- Industry Standard TO-220 Package
- High Speed: $E_{off} = 70 \mu\text{J}/\text{A}$ typical at 125°C
- High Voltage Short Circuit Capability – $10 \mu\text{s}$ minimum at 125°C , 400 V
- Low On-Voltage 2.0 V typical at 5.0 A, 125°C
- Soft Recovery Free Wheeling Diode is Included in the Package
- Robust High Voltage Termination
- ESD Protection Gate-Emitter Zener Diodes



MGP7N60ED

IGBT & DIODE IN TO-220
7.0 A @ 90°C
10 A @ 25°C
600 VOLTS
SHORT CIRCUIT RATED
LOW ON-VOLTAGE



MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CES}	600	Vdc
Collector-Gate Voltage ($R_{GE} = 1.0 \text{ M}\Omega$)	V_{CGR}	600	Vdc
Gate-Emitter Voltage — Continuous	V_{GE}	± 20	Vdc
Collector Current — Continuous @ $T_C = 25^\circ\text{C}$ — Continuous @ $T_C = 90^\circ\text{C}$ — Repetitive Pulsed Current (1)	I_{C25} I_{C90} I_{CM}	10 7.0 14	Adc Apk
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	81 0.65	Watts W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$
Short Circuit Withstand Time ($V_{CC} = 400 \text{ Vdc}$, $V_{GE} = 15 \text{ Vdc}$, $T_J = 125^\circ\text{C}$, $R_G = 20 \Omega$)	t_{sc}	10	μs
Thermal Resistance — Junction to Case — IGBT — Junction to Case — Diode — Junction to Ambient	$R_{\theta JC}$ $R_{\theta JA}$	1.5 2.7 65	$^\circ\text{C}/\text{W}$
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	T_L	260	$^\circ\text{C}$
Mounting Torque, 6-32 or M3 screw	10 lbf-in (1.13 N•m)		

(1) Pulse width is limited by maximum junction temperature. Repetitive rating.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-to-Emitter Breakdown Voltage (V _{GE} = 0 Vdc, I _C = 25 µAdc) Temperature Coefficient (Positive)	V _{(BR)CES}	600 —	— 870	—	Vdc mV/°C
Zero Gate Voltage Collector Current (V _{CE} = 600 Vdc, V _{GE} = 0 Vdc) (V _{CE} = 600 Vdc, V _{GE} = 0 Vdc, T _J = 125°C)	I _{CES}	— —	— —	10 200	µAdc
Gate-Body Leakage Current (V _{GE} = ± 20 Vdc, V _{CE} = 0 Vdc)	I _{GES}	—	—	50	µAdc
ON CHARACTERISTICS (1)					
Collector-to-Emitter On-State Voltage (V _{GE} = 15 Vdc, I _C = 2.5 Adc) (V _{GE} = 15 Vdc, I _C = 2.5 Adc, T _J = 125°C) (V _{GE} = 15 Vdc, I _C = 5.0 Adc)	V _{CE(on)}	— — —	1.6 1.5 2.0	1.9 — 2.4	Vdc
Gate Threshold Voltage (V _{CE} = V _{GE} , I _C = 1.0 mAdc) Threshold Temperature Coefficient (Negative)	V _{GE(th)}	4.0 —	6.0 10	8.0 —	Vdc mV/°C
Forward Transconductance (V _{CE} = 10 Vdc, I _C = 5.0 Adc)	g _{fe}	—	2.5	—	Mhos
DYNAMIC CHARACTERISTICS					
Input Capacitance	(V _{CE} = 25 Vdc, V _{GE} = 0 Vdc, f = 1.0 MHz)	C _{ies}	—	610	—
Output Capacitance		C _{oes}	—	60	—
Transfer Capacitance		C _{res}	—	10	—
SWITCHING CHARACTERISTICS (1)					
Turn-On Delay Time	(V _{CC} = 360 Vdc, I _C = 5.0 Adc, V _{GE} = 15 Vdc, L = 300 µH, R _G = 20 Ω) Energy losses include "tail"	t _{d(on)}	—	22	—
Rise Time		t _r	—	24	—
Turn-Off Delay Time		t _{d(off)}	—	64	—
Fall Time		t _f	—	196	—
Turn-Off Switching Loss		E _{off}	—	200	340
Turn-On Switching Loss		E _{on}	—	71	—
Total Switching Loss		E _{ts}	—	271	—
Turn-On Delay Time	(V _{CC} = 360 Vdc, I _C = 5.0 Adc, V _{GE} = 15 Vdc, L = 300 µH, R _G = 20 Ω, T _J = 125°C) Energy losses include "tail"	t _{d(on)}	—	31	—
Rise Time		t _r	—	24	—
Turn-Off Delay Time		t _{d(off)}	—	195	—
Fall Time		t _f	—	220	—
Turn-Off Switching Loss		E _{off}	—	350	—
Turn-On Switching Loss		E _{on}	—	135	—
Total Switching Loss		E _{ts}	—	485	—
Gate Charge	(V _{CC} = 360 Vdc, I _C = 5.0 Adc, V _{GE} = 15 Vdc)	Q _T	—	27.2	—
		Q ₁	—	7.0	—
		Q ₂	—	13.7	—

(1) Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.

DIODE CHARACTERISTICS

Diode Forward Voltage Drop ($I_{EC} = 2.3$ Adc) ($I_{EC} = 2.3$ Adc, $T_J = 125^\circ\text{C}$) ($I_{EC} = 4.6$ Adc)	V_{FEC}	— — —	1.7 1.3 2.0	— — 2.3	Vdc	
Reverse Recovery Time	($I_F = 4.6$ Adc, $V_R = 360$ Vdc, $dI_F/dt = 200$ A/ μs)	t_{rr}	—	40	—	
		t_a	—	17	—	
		t_b	—	23	—	
Reverse Recovery Stored Charge	($I_F = 4.6$ Adc, $V_R = 360$ Vdc, $dI_F/dt = 200$ A/ μs , $T_J = 125^\circ\text{C}$)	Q_{RR}	—	60	—	
Reverse Recovery Time		t_{rr}	—	105	—	
		t_a	—	36	—	
		t_b	—	69	—	
Reverse Recovery Stored Charge		Q_{RR}	—	247	nC	

INTERNAL PACKAGE INDUCTANCE

Internal Emitter Inductance (Measured from the emitter lead 0.25" from package to emitter bond pad)	L_E	—	7.5	—	nH
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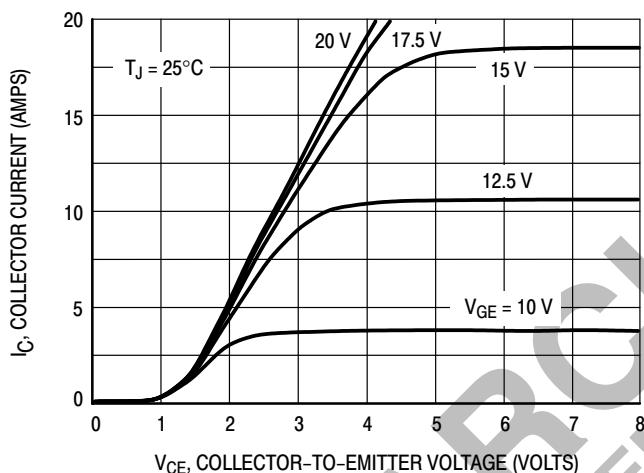


Figure 1. Output Characteristics

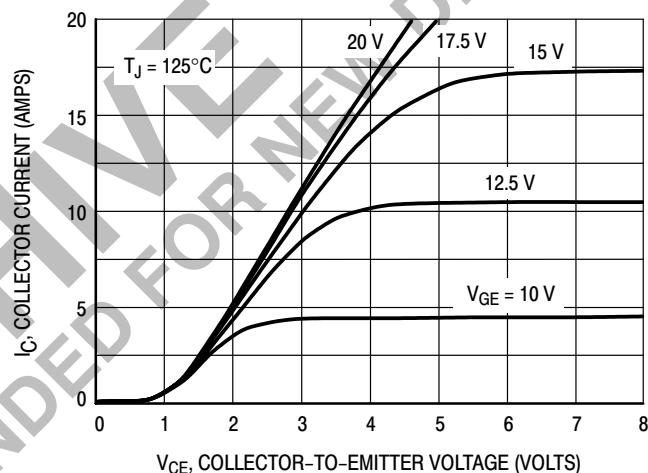


Figure 2. Output Characteristics

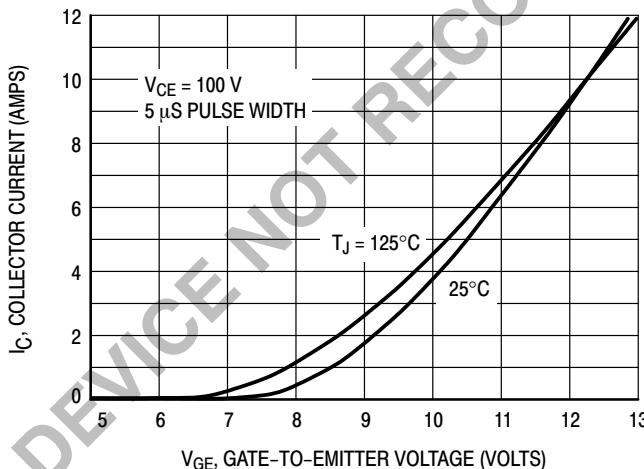


Figure 3. Transfer Characteristics

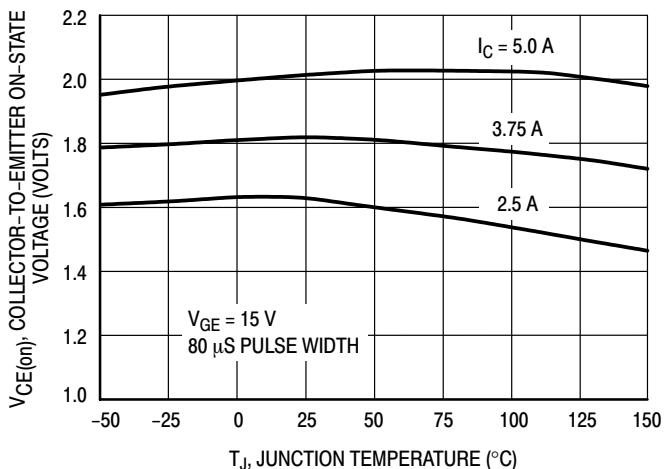


Figure 4. Collector-to-Emitter Saturation Voltage versus Junction Temperature

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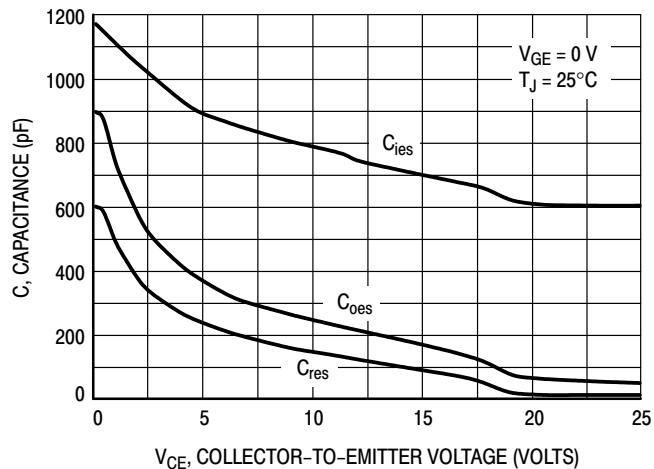


Figure 5. Capacitance Variation

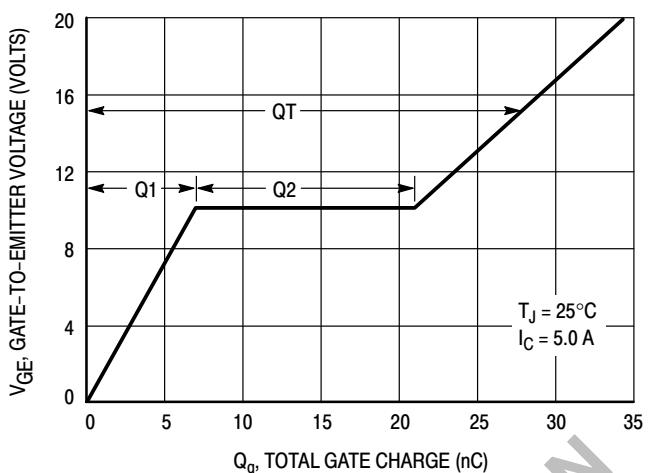


Figure 6. Gate-to-Emitter Voltage versus Total Charge

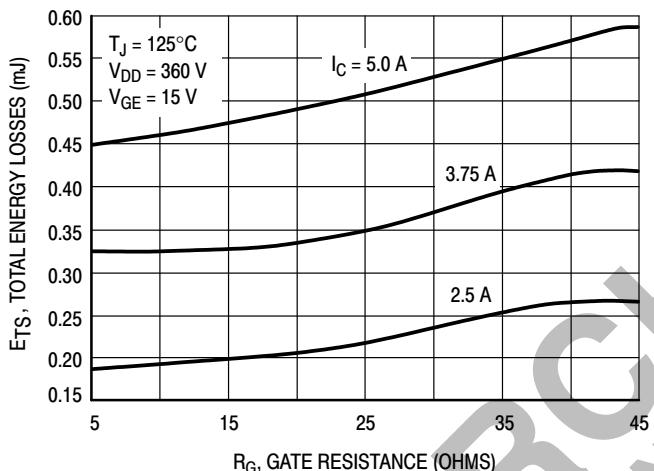


Figure 7. Total Energy Losses versus Gate Resistance

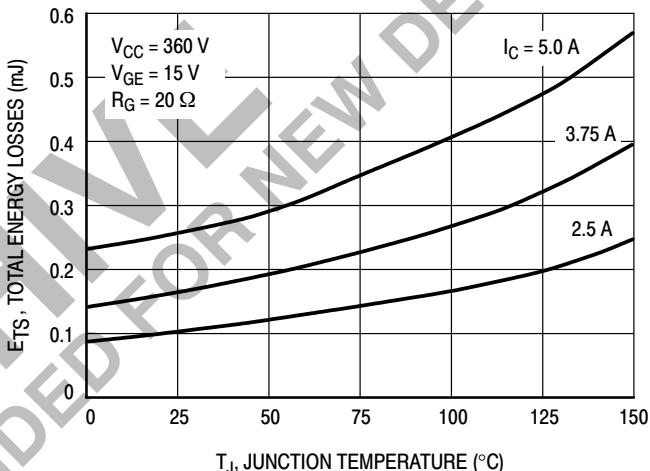


Figure 8. Total Energy Losses versus Junction Temperature

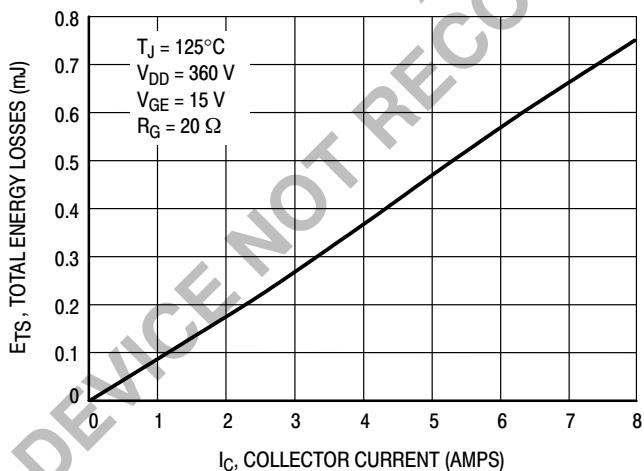


Figure 9. Total Energy Losses versus Collector Current

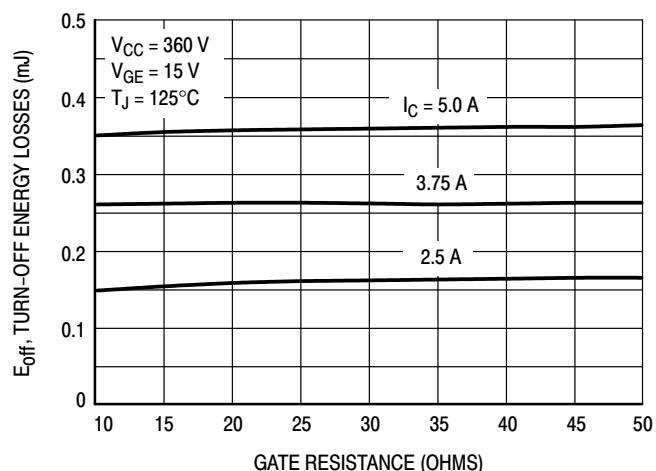
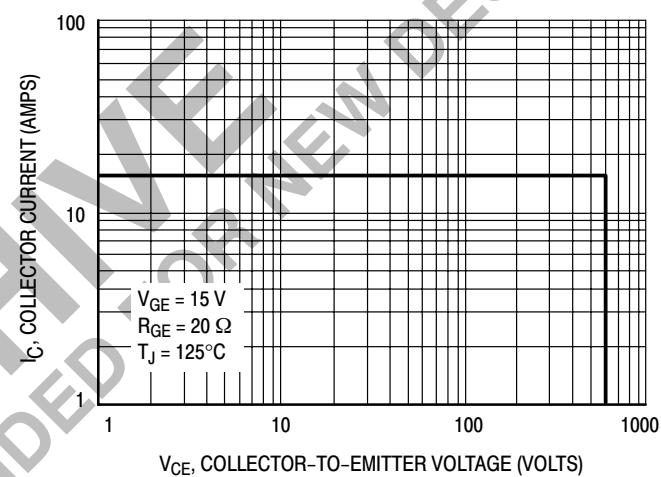
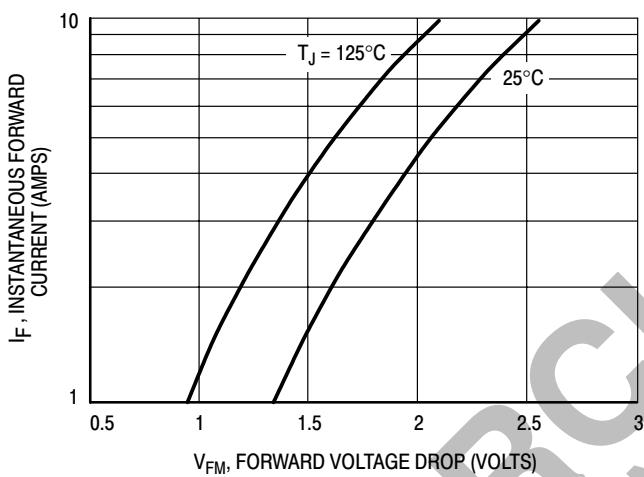
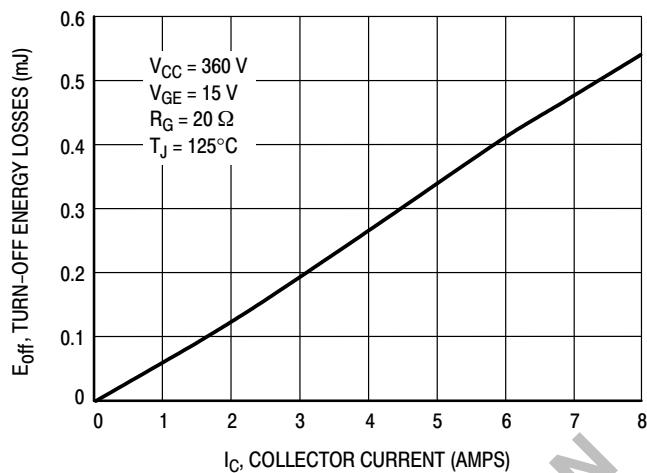
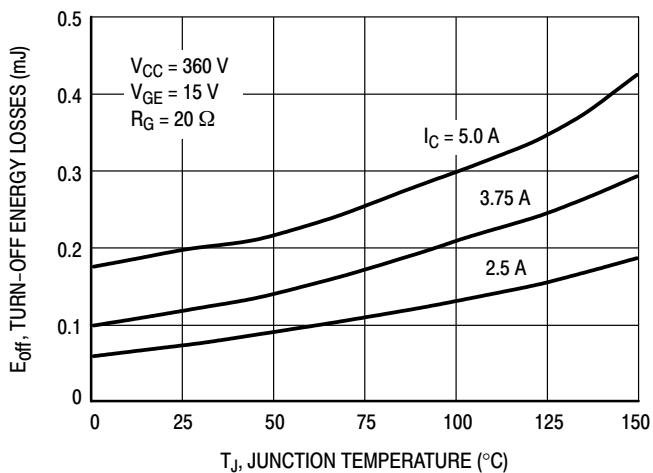
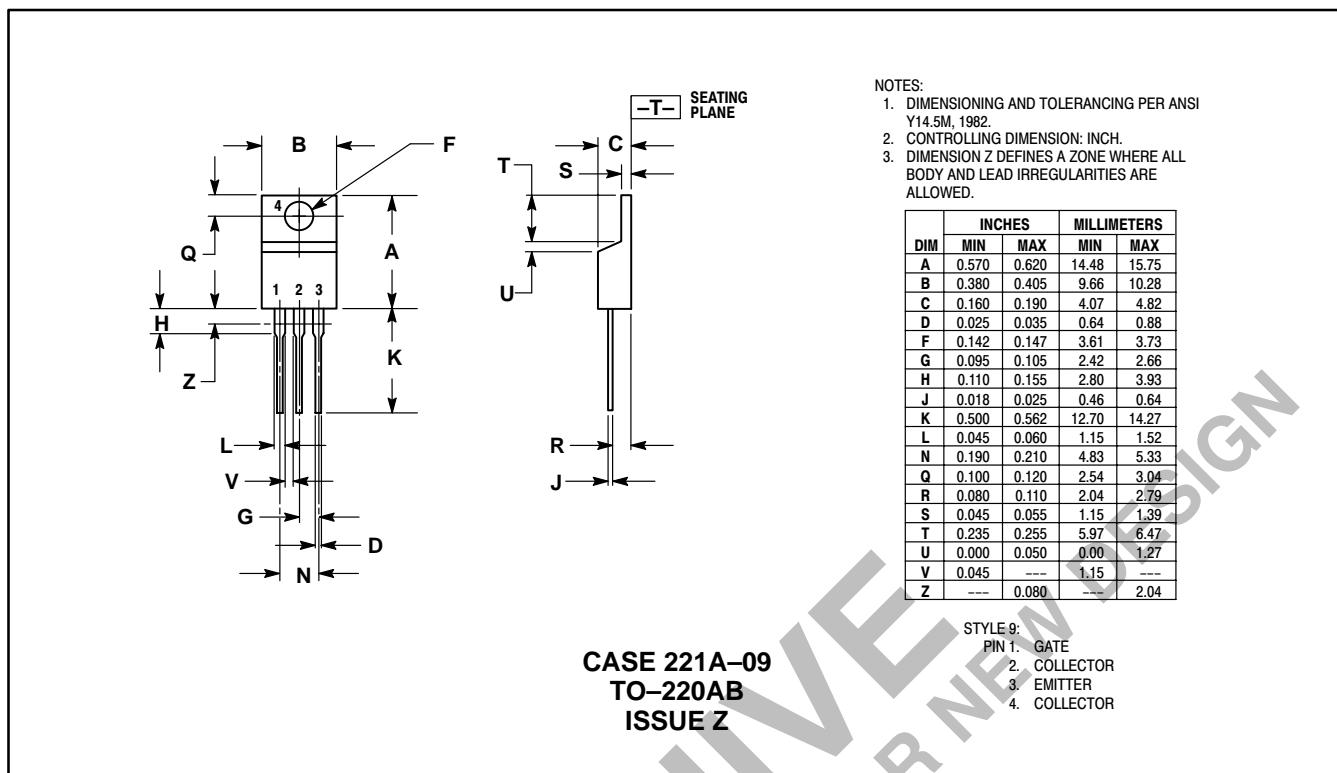


Figure 10. Turn-Off Losses versus Gate Resistance



DEVICE NOT RECOMMENDED FOR NEW DESIGN

PACKAGE DIMENSIONS



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